

GP1S092HCPI

Subminiature, Surface Mount Type Photointerrupter

■ Features

1. Subminiature, transmissive type (4.5×2.6×2.9mm)
2. Surface mount type
3. Wide gap (Gap width : 2mm)
4. Slit width (Detector side) : 0.3mm
5. Tape-packaged product

■ Applications

1. Cameras
2. CD-ROM drives
3. VCR

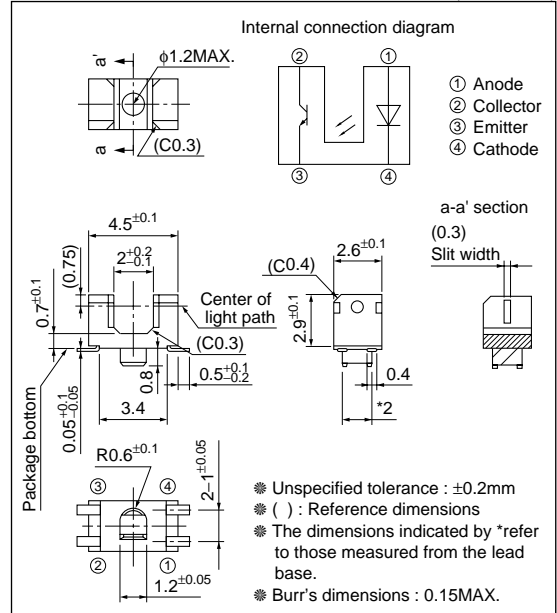
■ Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	50	mA
	Reverse voltage	V _R	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	V _{CEO}	35	V
	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	I _C	20	mA
	Collector power dissipation	P _C	75	mW
	Total power dissipation	P _{tot}	100	mW
	Operating temperature	T _{opr}	-25 to +85	°C
	Storage temperature	T _{stg}	-40 to +100	°C
	*1 Soldering temperature	T _{sol}	260	°C

*1 For MAX. 5s

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

(Ta=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F=20\text{mA}$	—	1.2	1.4	V
	Reverse current	I_R	$V_R=3\text{V}$	—	—	10	μA
Output	Collector dark current	I_{CEO}	$V_{CE}=20\text{V}$	—	—	100	nA
Transfer characteristics	Collector current	I_C	$V_{CE}=5\text{V}, I_F=5\text{mA}$	100	—	400	μA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F=10\text{mA}, I_C=40\mu\text{A}$	—	—	0.4	V
	Response time	Rise time	t_r	$V_{CE}=5\text{V}, I_C=100\mu\text{A}$ $R_L=1\ 000\Omega$	—	50	150
Fall time		t_f	—		50	150	μs

Fig.1 Forward Current vs. Ambient Temperature

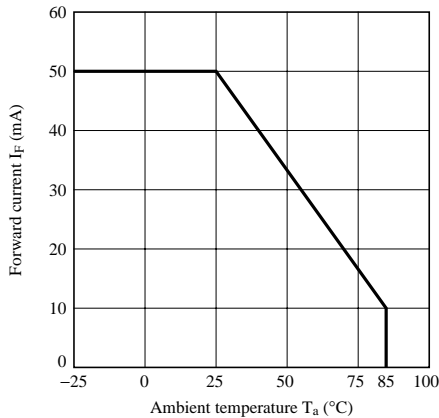


Fig.2 Power Dissipation vs. Ambient Temperature

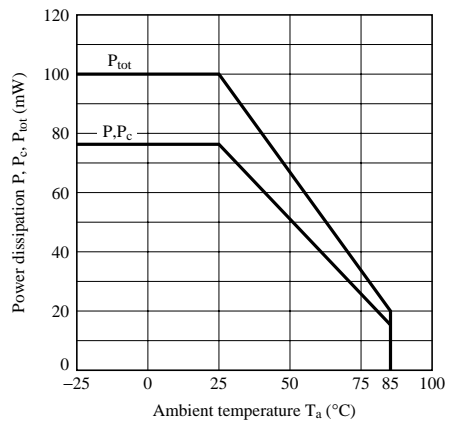


Fig.3 Forward Current vs. Forward Voltage

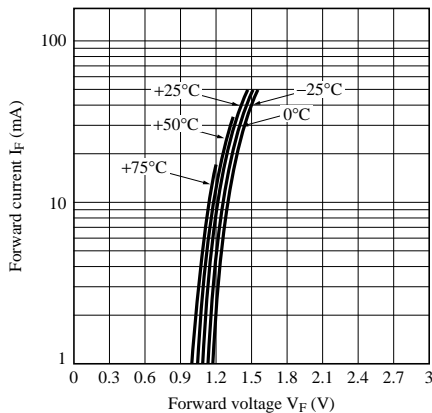


Fig.4 Collector Current vs. Forward Current

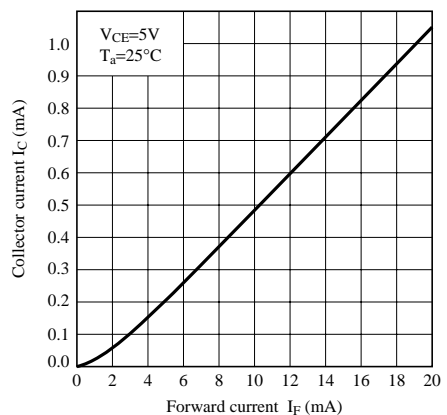


Fig.5 Collector Current vs. Collector-emitter Voltage

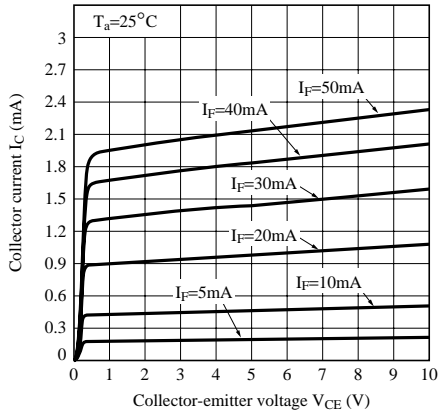


Fig.6 Relative Collector Current vs. Ambient Temperature

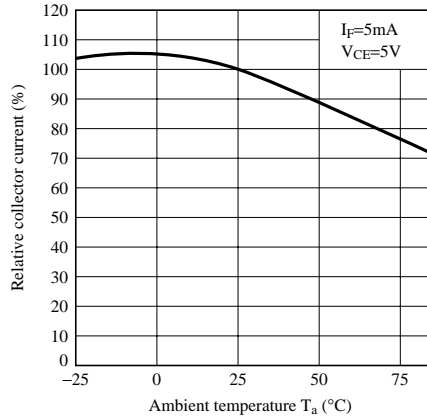


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

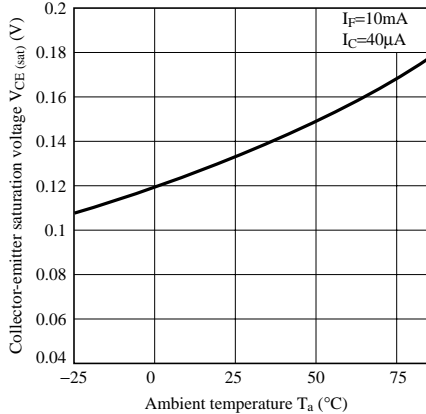


Fig.8 Collector Dark Current vs. Ambient Temperature

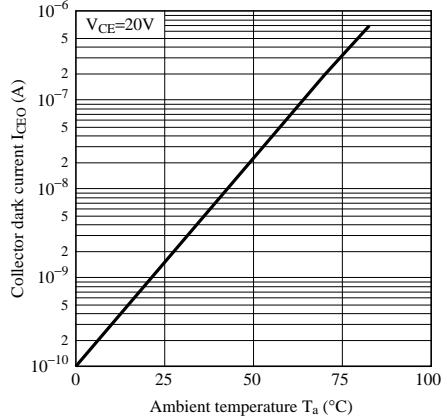


Fig.9 Response Time vs. Load Resistance

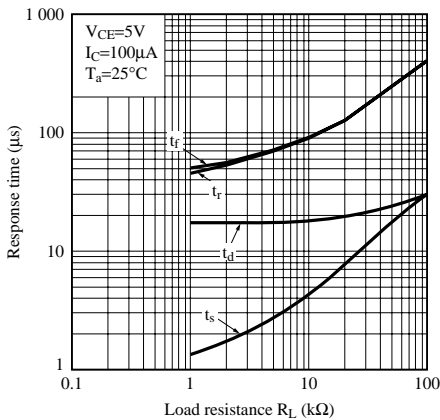


Fig.10 Test Circuit for Response Time

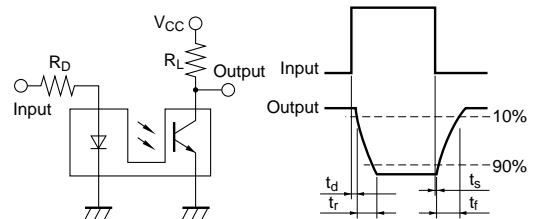


Fig.11 Relative Collector Current vs. Shield Distance (1)

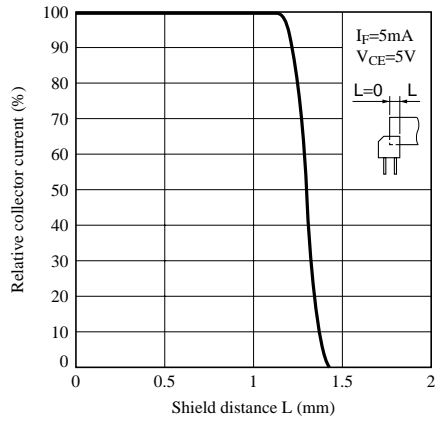
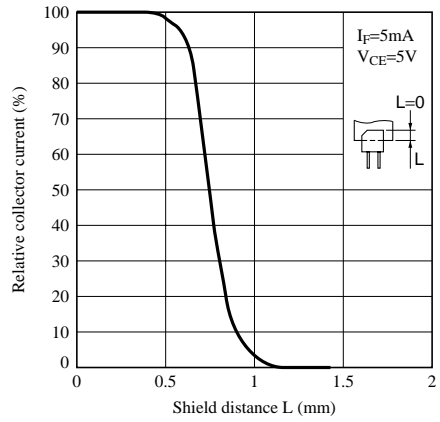


Fig.12 Relative Collector Current vs. Shield Distance (2)



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